

UD info Corp.

Industrial SATA Solid State Drive

HF3-25UB Series

Product DataSheet

UD info CORP.

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Revision History

Revision	Draft Date	History	Author
1.0	2016/7/14	New release	Golden Lee
1.1	2016/12/13	Change physical dimension	Golden Lee
1.2	2017/3/31	Add 32GB capacity support	Golden Lee
1.3	2017/4/18	Add 8GB/16GB support	Golden Lee
1.4	2017/5/2	Add pSLC support	Golden Lee
1.5	2017/11/9	Modify TBW	Golden Lee
1.6	2017/11/21	Add 3D TLC Flash support	Golden Lee
1.7	2018/2/23	Update 3D TLC TBW	Golden Lee
1.8	2018/3/20	Update 3D TLC density support	Golden Lee
1.9	2018/4/11	Add SLC support	Golden Lee
2.0	2018/4/25	Add WP and QE function description	Golden Lee
2.1	2018/5/16	Add SLC 64GB/128GB support	Golden Lee
2.2	2018/6/28	Add SLC TBW data	Golden Lee
2.3	2018/8/17	Update 3D Bics3 Capacity and TBW	Golden Lee
2.4	2019/1/18	Add P/N decoder for 3D wide temperature support	Golden Lee

Product Overview

- **Capacity**
 - MLC: 4GB up to 512GB
 - pSLC: 2GB up to 256GB
 - 3D Bics3: 32GB up to 1TB
 - SLC: 8GB up to 128GB
- **SATA Interface**
 - SATA Revision 3.2
 - SATA 1.5Gbps, 3Gbps, and 6Gbps interface
- **Flash Interface**
 - Flash Type: MLC, 3D Bics3 TLC, SLC
- **Performance**
 - Read up to 550 MB/s
 - Write up to 500 MB/s
- **Power Consumption**^{Note1}
 - Active mode: < 2,650 mW
 - Idle mode: < 325 mW
- **TBW (Terabyte Written)**^{Note2}
 - MLC: 540 TBW for 512GB
 - pSLC: 1,510 TBW for 256GB
 - 3D Bics3: 835 TBW for 1TB
 - SLC: 2,133 TBW for 128GB
- **MTBF**
 - MLC/3D Bics3: 2,000,000 hours
 - pSLC: 2,500,000 hours
 - SLC: 3,000,000 hours
- **Advanced Flash Management**
 - Static and Dynamic Wear Leveling
 - Bad Block Management
 - TRIM
 - SMART
 - Over-Provision
- **Low Power Management**
 - DIPM/HIPM Mode
 - DEVSLP Mode (Optional)
- **Temperature Range**
 - Operation (Standard): 0°C ~ 70°C
 - Operation (Wide): -40°C ~ 85°C
 - Storage: -40°C ~ 85°C
- **Compliant**
 - RoHS
 - CE & FCC

Notes:

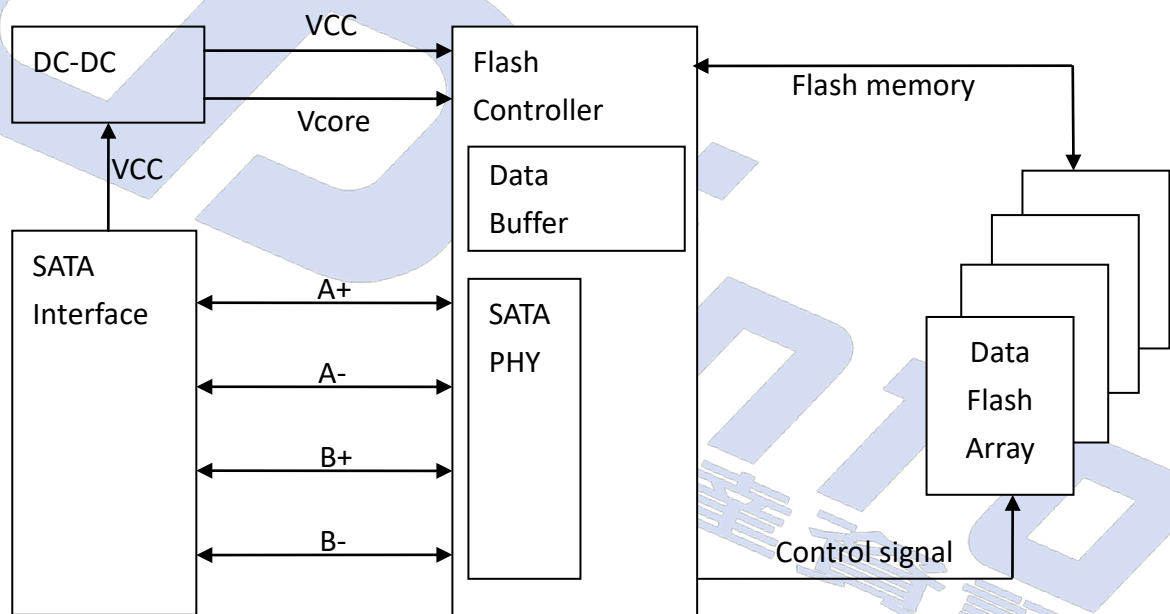
1. Please see "Power Consumption" for details.
2. Please see "TBW (Terabytes Written)" in chapter 2 for details.

1. INTRODUCTION

1.1. General Description

UDinfo 2.5" SATA SSD delivers all the advantages of flash disk technology with Serial ATA I/II/III interface, including being fully compliant with standard 2.5-inch form factor, providing low power consumption compared to traditional hard drive and hot-swapping when removing/replacing/upgrading flash disks. The device is designed based on the standard 7-pin interface for data segment and 15-pin for power segment, as well as operating at a maximum operating frequency of 200MHz with 30MHz external crystal. Its capacity could provide a wide range up to 512GB. Moreover, it can reach up to 550MB/s read as well as 500MB/s write high performance based on Toshiba's NAND flash (with 32MB SDR cache enabled and measured by CrystalDiskMark v5.0).

1.2. Block Diagram



2.5" SATA SSD Block Diagram

2. PRODUCT SPECIFICATIONS



- **Capacity**
 - MLC: From 4GB up to 512GB (support 48-bit addressing mode)
 - pSLC: From 2GB up to 256GB (support 48-bit addressing mode)
 - 3D Bics3: From 32GB up to 1TB (support 48-bit addressing mode)
 - SLC: From 8GB up to 128GB (support 48-bit addressing mode)
- **Electrical/Physical Interface**
 - SATA Interface
 - ◆ Compliant with SATA Revision 3.2
 - ◆ Compatible with SATA 1.5Gbps, 3Gbps and 6Gbps interface
 - ◆ Support power management
 - ◆ Support expanded register for SATA protocol 48 bits addressing mode
 - ◆ Embedded BIST function for SATA PHY for low cost mass production
- **Built-in 2-channel NAND flash interface controller**
 - Compliant with Toggle 1.0 and Toggle 2.0 NAND Flash interface
 - Compliant with ONFI 4.0 interface:
 - ◆ SDR up to mode 5
 - ◆ NV-DDR up to mode 5
 - ◆ NV-DDR2 up to mode 7
 - ◆ NV-DDR3 up to mode 8
- **Supported NAND Flash**
 - Support up to 16 Flash Chip Enables (CE) within single design
 - Toshiba 24nm/15nm/3D-NAND MLC and TLC
 - Support all types of SLC/MLC/TLC/3D-NAND, 8KB/page and 16K/page NAND flash
- **ECC Scheme**
 - Applies the LDPC (Low Density Parity Check) of ECC algorithm
- **UART function**
- **GPIO**
- **Support SMART and TRIM commands**

● Capacity Information

Capacity	Cylinders	Heads	Sectors	Total Sectors	User Data Size
2GB	3,897	16	63	3,928,176	Depended on file management
4GB	7,773	16	63	7,835,184	
8GB	15,525	16	63	15,649,200	
16GB	16,383	16	63	31,277,232	
30GB	16,383	16	63	58,626,288	
32GB	16,383	16	63	62,533,296	
60GB	16,383	16	63	117,231,408	
64GB	16,383	16	63	125,045,424	
120GB	16,383	16	63	234,441,648	
128GB	16,383	16	63	250,069,680	
240GB	16,383	16	63	468,862,128	
256GB	16,383	16	63	500,118,192	
480GB	16,383	16	63	937,703,088	
512GB	16,383	16	63	1,000,215,216	
960GB	16,383	16	63	1,875,385,008	
1TB	16,383	16	63	2,000,409,264	

● Performance

■ MLC:

Capacity	Flash Structure	Flash Type	Sequential	
			Read (MB/s)	Write (MB/s)
4GB	4GB x 1	15nm, TSOP	160	50
8GB	8GB x 1	15nm, TSOP	160	90
16GB	16GB x 1	15nm, TSOP	320	80
30GB/32GB	16GB x 2	15nm, TSOP	550	160
60GB/64GB	16GB x 4	15nm, TSOP	550	310
120GB/128GB	32GB x 4	15nm, BGA	550	460
	64GB x 2	15nm, BGA	550	460
240GB/256GB	64GB x 4	15nm, BGA	550	490
480GB/512GB	128GB x 4	15nm, BGA	550	490

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■ pSLC:

Capacity	Flash Structure	Flash Type	Sequential	
			Read (MB/s)	Write (MB/s)
2GB	4GB x 1	15nm, TSOP	160	50
4GB	8GB x 1	15nm, TSOP	160	90
8GB	16GB x 1	15nm, TSOP	300	80
16GB	16GB x 2	15nm, TSOP	550	160
30GB/32GB	16GB x 4	15nm, TSOP	550	310
60GB/64GB	32GB x 4	15nm, BGA	550	460
	64GB x 2	15nm, BGA	550	460
120GB/128GB	64GB x 4	15nm, BGA	550	490
240GB/256GB	128GB x 4	15nm, BGA	550	490

■ 3D Bics3:

Capacity	Flash Structure	Flash Type	Sequential	
			Read (MB/s)	Write (MB/s)
30GB/32GB	32GB x 1	TSB Bics3, TSOP	300	120
60GB/64GB	32GB x 2	TSB Bics3, TSOP	550	250
120GB/128GB	32GB x 4	TSB Bics3, TSOP	550	450
	64GB x 2	TSB Bics3, TSOP	550	450
		TSB Bics3, BGA	550	450
240GB/256GB	64GB x 4	TSB Bics3, TSOP	550	490
	128GB x 2	TSB Bics3, TSOP	550	490
	128GB x 2	TSB Bics3, BGA	550	490
480GB/512GB	128GB x 4	TSB Bics3, TSOP	550	490
		TSB Bics3, BGA	550	490
	256GB x 2	TSB Bics3, BGA	550	490
960GB/1TB	128GB x 8	TSB Bics3, TSOP	550	490
	256GB x 4	TSB Bics3, BGA	550	500

■ SLC:

Capacity	Flash Structure	Flash Type	Sequential	
			Read (MB/s)	Write (MB/s)
8GB	8GB x 1	24nm, BGA	320	70
16GB	8GB x 2	24nm, BGA	540	150
32GB	16GB x 2	24nm, BGA	510	300
64GB	32GB x 2	24nm, BGA	510	310
128GB	32GB x 4	24nm, BGA	480	420

Notes:

1. The performance was estimated based on Toshiba NAND flash.
2. Performance may differ according to flash configuration and platform.
3. The table above is for reference only.

- **TBW (Terabytes Written)**

- **MLC:**

Capacity	Flash Structure	TBW
4GB	4GB x 1	1
8GB	8GB x 1	3
16GB	16GB x 1	6
30GB/32GB	16GB x 2	13
60GB/64GB	16GB x 4	30
120GB/128GB	32GB x 4	87
240GB/256GB	64GB x 4	198
480GB/512GB	128GB x 4	540

- **pSLC:**

Capacity	Flash Structure	TBW
2GB	4GB x 1	4
4GB	8GB x 1	10
8GB	16GB x 1	21
16GB	16GB x 2	49
30GB/32GB	16GB x 4	106
60GB/64GB	32GB x 4	215
120GB/128GB	64GB x 4	649
240GB/256GB	128GB x 4	1510

- **3D Bics3:**

Capacity	Flash Structure	TBW
32GB	32GB x 1	17
64GB	32GB x 2	42
128GB	32GB x 4	75
256GB	128GB x 2	180
512GB	128GB x 4	425
1TB	256GB x 4	835

■ SLC:

Capacity	Flash Structure	TBW
8GB	8GB x 1	74
16GB	8GB x 2	153
32GB	16GB x 2	325
64GB	32GB x 2	761
128GB	32GB x 4	2133

Notes:

1. Samples were built using Toshiba NAND flash.
2. The test followed JEDEC219A client endurance workload.
3. TBW may differ according to flash configuration and platform.
4. The endurance of SSD could be estimated based on user behavior, NAND endurance cycles, and write amplification factor. It is not guaranteed by flash vendor.

3. ENVIRONMENTAL SPECIFICATIONS



3.1. Environmental Conditions

3.1.1. Temperature and Humidity

- Temperature:
 - ◆ Storage: -40°C to 85°C
 - ◆ Operational (Standard grade): 0°C to 70°C
 - ◆ Operational (Wide grade): -40°C to 85°C
- Humidity:
 - ◆ Standard grade: RH 90% under 40°C (operational)
 - ◆ Wide grade: RH 95% under 55°C (operational)

■ High Temperature Test Condition

	Temperature	Humidity	Test Time
Operation (Standard)	70°C	0% RH	72 hours
Operation (Wide)	85°C	0% RH	72 hours
Storage (Standard)	85°C	0% RH	72 hours
Storage (Wide)	85°C	0% RH	168 hours

Result: No any abnormality is detected.

■ Low Temperature Test Condition

	Temperature	Humidity	Test Time
Operation (Standard)	0°C	0% RH	72 hours
Operation (Wide)	-40°C	0% RH	72 hours
Storage (Standard)	-40°C	0% RH	72 hours
Storage (Wide)	-40°C	0% RH	168 hours

Result: No any abnormality is detected.

■ High Humidity Test Condition

	Temperature	Humidity	Test Time
Operation (Standard)	40°C	93% RH	24 hours
Operation (Wide)	55°C	95% RH	72 hours
Storage (Standard)	40°C	95% RH	72 hours
Storage (Wide)	55°C	95% RH	96 hours

Result: No any abnormality is detected.

■ Temperature Cycle Test

	Temperature	Test Time	Cycle
Operation (Standard)	0°C	30 min	10 cycles
	70°C	30 min	
Operation (Wide)	-40°C	30 min	20 cycles
	85°C	30 min	
Storage (Standard)	-40°C	30 min	10 cycles
	85°C	30 min	
Storage (Wide)	-40°C	30 min	50 cycles
	85°C	30 min	

Result: No any abnormality is detected.

3.1.2. Shock

■ Shock Specification

	Acceleration Force	Half Sin Pulse Duration
Non-Operational	1500G	0.5ms
Operational	1500G	0.5ms

Result: No any abnormality is detected when power on.

3.1.3. Vibration

■ Vibration Specification

	Condition		Vibration Orientation
	Frequency/Displacement	Frequency/Acceleration	
Operational	20Hz~80Hz/1.52mm	80Hz~2000Hz/20G	X, Y, Z axis/60 min for each

Result: No any abnormality is detected when power on.

3.1.4. Drop

■ Drop Specification

	Height of Drop	Number of Drop
Non-operational	80cm free fall	6 face of each unit, 2 times each

Result: No any abnormality is detected when power on.

3.1.5. Bending

■ Bending Specification

	Force	Action
Non-operational	≥ 20N	Hold 1min/5times

Result: No any abnormality is detected when power on.

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3.1.6. Torque

■ Torque Specification

	Force	Action
Non-operational	1.263N-m or ± 10 deg	Hold 1min/5times

Result: No any abnormality is detected when power on.

3.1.7. Electrostatic Discharge (ESD)

■ Contact ESD Specification

Device	Capacity	Temperature	Relative Humidity	+/- 4KV	Result
2.5" SSD	256GB	24.0°C	49% (RH)	Device functions are affected, but EUT will be back to its normal or operational state automatically.	PASS
	512GB				

3.2. MTBF

MTBF, an acronym for Mean Time between Failures, is a measure of a device's reliability. Its value represents the average time between a repair and the next failure. The measure is typically in units of hours. The higher the MTBF value, the higher the reliability of the device. The predicted result of UDinfo's 2.5" SATA SSD is up to 3,000,000 hours.

3.3. Certification

- RoHS
- CE / FCC

3.4. Compliance

- SATA III (SATA Rev. 3.2)
- Up to ATA/ATAPI-8 (Including S.M.A.R.T)

4. ELECTRICAL SPECIFICATIONS



4.1. Supply Voltage

Parameter	Rating
Operating Voltage	5V $\pm$ 5% (4.75V~5.25V)
Rise Time (Max/min)	100ms / 0.1ms
Fall Time (Max/min)	5s / 1ms

4.2. Power Consumption

■ MLC

Capacity	Flash Structure	Flash Type	Read	Write	Partial	Slumber	Idle	DEVSLP
4GB	4GB x 1	15nm, TSOP	1,120	1,150	13	9	265	4.9
8GB	8GB x 1	15nm, TSOP	1,150	1,180	13	9	265	4.9
16GB	16GB x 1	15nm, TSOP	1,180	1,200	13.5	9	265	4.9
32GB	16GB x 2	15nm, TSOP	1,200	1,280	14	10	265	4.9
64GB	16GB x 4	15nm, TSOP	1,200	1,320	15	11	265	4.9
128GB	32GB x 4	15nm, BGA	1,280	1,700	15	10	280	4.9
	64GB x 2	15nm, BGA	1,250	1,600	15	10	275	4.9
256GB	64GB x 4	15nm, BGA	1,350	2,600	15	10	280	4.9
512GB	128GB x 4	15nm, BGA	1,500	2,650	16.5	11	318	4.9

Unit: mW

■ pSLC

Capacity	Flash Structure	Flash Type	Read	Write	Partial	Slumber	Idle	DEVSLP
2GB	4GB x 1	15nm, TSOP	1,120	1,150	13	9	265	4.9
4GB	8GB x 1	15nm, TSOP	1,150	1,180	13	9	265	4.9
8GB	16GB x 1	15nm, TSOP	1,180	1,200	13.5	9	265	4.9
16GB	16GB x 2	15nm, TSOP	1,200	1,280	14	10	265	4.9
32GB	16GB x 4	15nm, TSOP	1,200	1,320	15	11	265	4.9
64GB	32GB x 4	15nm, BGA	1,280	1,700	15	10	280	4.9
	64GB x 2	15nm, BGA	1,250	1,600	15	10	275	4.9
128GB	64GB x 4	15nm, BGA	1,350	2,600	15	10	280	4.9
256GB	128GB x 4	15nm, BGA	1,500	2,650	16.5	11	318	4.9

Unit: mW

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■ 3D Bics3

Capacity	Flash Structure	Flash Type	Read	Write	Partial	Slumber	Idle	DEVSLP
32GB	32GB x 1	TSB Bics3, TSOP	1100	1000	22.5	15.5	325	4.9
64GB	32GB x 2	TSB Bics3, TSOP	1230	1020	20	14	320	4.9
128GB	32GB x 4	TSB Bics3, TSOP	1300	1350	20	14	320	4.9
	64GB x 2	TSB Bics3, TSOP	1300	1350	20	14	320	4.9
		TSB Bics3, BGA	1450	1550	20	15	325	4.9
256GB	64GB x 4	TSB Bics3, TSOP	1350	1450	20	14	325	4.9
	128GB x 2	TSB Bics3, TSOP	1170	1360	19	14	315	4.9
	128GB x 2	TSB Bics3, BGA	1350	1490	20	15	325	4.9
512GB	128GB x 4	TSB Bics3, TSOP	1360	1660	22	16	320	4.9
		TSB Bics3, BGA	1470	1670	20	15	320	4.9
	256GB x 2	TSB Bics3, BGA	1470	1670	20	15	320	4.9
1TB	128GB x 8	TSB Bics3, TSOP	1620	1750	22	16	320	4.9
	256GB x 4	TSB Bics3, BGA	1575	1680	20	15	320	4.9

Unit: mW

■ SLC

Capacity	Flash Structure	Flash Type	Read	Write	Partial	Slumber	Idle	DEVSLP
8GB	8GB x 1	24nm, BGA	1,200	1,000	20	15	315	4.9
16GB	8GB x 2	24nm, BGA	1,600	1,250	20	15	320	4.9
32GB	16GB x 2	24nm, BGA	1,650	1,730	20	15	325	4.9
64GB	32GB x 2	24nm, BGA	1,700	2,000	20	15	325	4.9
128GB	32GB x 4	24nm, BGA	1,700	2,300	20	15	325	4.9

Unit: mW

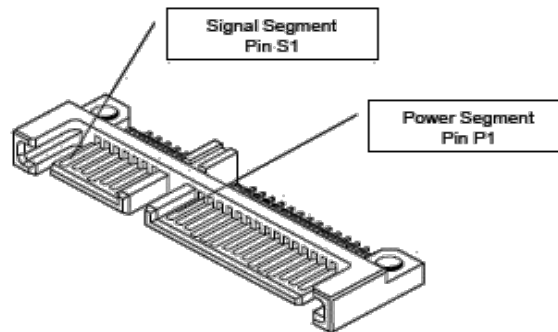
Notes:

1. It's average value of power consumption is achieved based on 100% conversion efficiency.
2. The measured power voltage is 5V.
3. Samples were built using Toshiba NAND flash and measured under normal temperature.
4. Sequential R/W is measured while testing 4000MB sequential R/W 5 times by CrystallDiskMark.
5. Power Consumption may differ according to flash configuration and platform.

5. INTERFACE



5.1. Pin Assignment and Descriptions



Signal Segment Pin Assignment	Pin Number	Function
	S1	GND
	S2	A+ (Differential Signal Pair A)
	S3	A – (Differential Signal Pair A)
	S4	GND
	S5	B – (Differential Signal Pair B)
	S6	B+ (Differential Signal Pair B)
	S7	GND
Power Segment Pin Assignment	Pin Number	Function
	P1	Not Used (3.3V)
	P2	Not Used (3.3V)
	P3	DEVSLP
	P4	GND
	P5	GND
	P6	GND
	P7	5V pre-charge
	P8	5V
	P9	5V
	P10	GND
	P11	Reserved
	P12	GND
	P13	Not Used (12V pre-charge)
	P14	Not Used (12V)
	P15	Not Used (12V)

6. SUPPORTED COMMANDS



6.1. ATA Command List

Op-Code		Command Description	Op-Code		Command Description
00h		NOP	60h		Read FPDMA Queued
06h		Data Set Management	61h		Write FPDMA Queued
10h		Recalibrate	70h		Seek
20h		Read Sectors	90h		Execute Device Diagnostic
21h		Read Sectors without Retry	91h		Initialize Device Parameters
24h		Read Sectors EXT	92h		Download Microcode
25h		Read DMA EXT	93h		Download Microcode DMA
27h		Read Native Max Address EXT	B0h		SMART
29h		Read Multiple EXT	B0h	D0h	SMART READ DATA
2Fh		Read Log EXT	B0h	D1h	SMART READ DATA ATTRIBUTE THRESHOLD
30h		Write Sectors	B0h	D2h	SMART ENABLE/DISABLE ATTRIBUTE AUTOSAVE
31h		Write Sectors without Retry	B0h	D3h	SMART SAVE ATTRIBUTE VALUES
34h		Write Sectors EXT	B0h	D4h	SMART EXECUTE OFF-LINE IMMEDIATE
35h		Write DMA EXT	B0h	D5h	SMART READ LOG
37h		Set Native Max Address EXT	B0h	D6h	SMART WRITE LOG
39h		Write Multiple EXT	B0h	D8h	SMART ENABLE OPERATIONS
3Dh		Write DMA FUA EXT	B0h	D9h	SMART DISABLE OPERATIONS
3Fh		Write Long EXT	B0h	DAh	SMART RETURN STATUS
40h		Read Verify Sectors	B0h	DBh	SMART ENABLE/DISABLE AUTOMATIC OFF-LINE
41h		Read Verify Sectors without Retry	B1h		DEVICE CONFIGURATION OVERLAY
42h		Read Verify Sectors EXT	B1h	C0h	DEVICE CONFIGURATION RESTORE
45h		Write Uncorrectable EXT	B1h	C1h	DEVICE CONFIGURATION FREEZE LOCK
47h		Read Log DMA EXT	B1h	C2h	DEVICE CONFIGURATION IDENTIFY
57h		Write Log DMA EXT	B1h	C3h	DEVICE CONFIGURATION SET
B1h	C4h	DEVICE CONFIGURATION IDENTIFY DMA	ECh		Identify Device
B1h	C5h	DEVICE CONFIGURATION SET DMA	EFh		Set Features
C4h		Read Multiple	EFh	02h	Enable 8-bit PIO transfer mode

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Op-Code		Command Description	Op-Code		Command Description
C5h		Write Multiple	EFh	03h	Set transfer mode based on value in Count field
C6h		Set Multiple Mode	EFh	05h	Enable advanced power management
C8h		Read DMA	EFh	10h	Enable use of Serial ATA feature
C9h		Read DMA without Retry	EFh	10h 02h	Enable DMA Setup FIS Auto-Activate optimization
CAh		Write DMA	EFh	10h 03h	Enable Device-initiated interface power state (DIPM) transitions
CBh		Write DMA without Retry	EFh	10h 06h	Enable Software Settings Preservation (SSP)
CEh		Write Multiple FUA EXT	EFh	10h 07h	Enable Device Automatic Partial to Slumber transitions
E0h		Standby Immediate	EFh	10h 09h	Enable Device Sleep
E1h		Idle Immediate	EFh	55h	Disable read look-ahead feature
E2h		Standby	EFh	66h	Disable reverting to power-on defaults
E3h		Idle	EFh	82h	Disable write cache
E4h		Read Buffer	EFh	85h	Disable advanced power management
E5h		Check Power Mode	EFh	90h	Disable use of Serial ATA feature set
E6h		Sleep	EFh	90h 02h	Disable DMA Setup FIS Auto-Activate optimization
E7h		Flush Cache	EFh	90h 03h	Disable Device-initiated interface power state (DIPM) transitions
E8h		Write Buffer	EFh	90h 06h	Disable Software Settings Preservation (SSP)
E9h		Read Buffer DMA	EFh	90h 07h	Disable Device Automatic Partial to Slumber transitions
EAh		Flush Cache EXT	EFh	90h 09h	Disable Device Sleep
EBh		Write Buffer DMA	EFh	AAh	Enable read look-ahead feature
EFh	CCh	Enable reverting to power-on defaults	F4h		Security Erase Unit
F1h		Security Set Password	F5h		Security Freeze Lock
F2h		Security Unlock	F6h		Security Disable Password
F3h		Security Erase Prepare	F8h		Read Native Max Address

6.2. Identify Device Data

The following table details the sector data returned by the IDENTIFY DEVICE command.

Word	F: Fixed V: Variable X: retired/obsolete /reserved	Default Value	Description
0	F	0040h	General configuration bit-significant information
1	X	*1	Obsolete – Number of logical cylinders
2	F	C837h	Specific configuration
3	X	0010h	Obsolete – Number of logical heads (16)
4-5	X	00000000h	Retired
6	X	003Fh	Obsolete – Number of logical sectors per logical track (63)
7-8	X	00000000h	Reserved for assignment by the Compact Flash Association
9	X	0000h	Retired
10-19	V	Varies	Serial number (20 ASCII characters)
20-21	X	0000h	Retired
22	X	0000h	Obsolete
23-26	V	Varies	Firmware revision (8 ASCII characters)
27-46	V	Varies	Model number (xxxxxxxx)
47	F	8010h	7:0- Maximum number of sectors transferred per interrupt on MULTIPLE commands
48	F	4000h	Reserved
49	F	2F00h	Capabilities
50	F	4000h	Capabilities
51-52	X	000000000h	Obsolete
53	F	0007h	Words 88 and 70:64 valid
54	X	*1	Obsolete – Number of logical cylinders
55	X	0010h	Obsolete – Number of logical heads (16)
56	X	003Fh	Obsolete – Number of logical sectors per track (63)
57-58	X	*2	Obsolete – Current capacity in sectors
59	F	0110h	Number of sectors transferred per interrupt on MULTIPLE commands
60-61	V	*3	Maximum number of sector (28bit LBA mode)
62	X	0000h	Obsolete
63	F	0407h	Multi-word DMA modes supported/selected

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Word	F: Fixed V: Variable X: retired/obsolete /reserved	Default Value	Description
64	F	0003h	PIO modes supported
65	F	0078h	Minimum Multiword DMA transfer cycle time per word
66	F	0078h	Manufacturer's recommended Multiword DMA transfer cycle time
67	F	0078h	Minimum PIO transfer cycle time without flow control
68	F	0078h	Minimum PIO transfer cycle time with IORDY flow control
69	F	1F00h	Additional Supported
70	X	0000h	Reserved
71-74	X	000000000000 0000h	Reserved for the IDENTIFY PACKET DEVICE command
75	F	001Fh	Queue depth
76	F	850Eh	Serial SATA capabilities
77	F	0006h	Supported Serial ATA Phy speed
78	F	004Ch	Serial ATA features supported
79	F	0040H	Serial ATA features enabled
80	F	0FF8h	Major Version Number
81	F	0000h	Minor Version Number
82	F	746Bh	Command set supported
83	F	7D01h	Command set supported
84	F	4163h	Command set/feature supported extension
85	F	7469h	Command set/feature supported or enabled
86	F	BC01h	Command set/feature supported or enabled
87	F	4163h	Command set/feature supported or enabled
88	F	007Fh	Ultra DMA Modes
89	F	000Ah	Time required for Normal Erase mode SECURITY ERASE UNIT command
90	F	001Eh	Time required for an Enhanced Erase mode SECURITY ERASE UNIT command
91	F	0000h	Current advanced power management value
92	F	FFFEh	Master Password Revision Code
93	F	0000h	Hardware reset result. The contents of the bits (12:0) of this word can be changed only during the execution of hardware

			reset.
Word	F: Fixed V: Variable X: retired/obsolete /reserved	Default Value	Description
94	X	0000h	Vendor's recommended and actual acoustic management value
95	F	0000h	Stream Minimum Request Size
96	F	0000h	Streaming Transfer Time – DMA
97	F	0000h	Streaming Access Latency – DMA and PIO
98-99	F	0000h	Streaming Performance Granularity
100-103	V	*4	Maximum user LBA for 48 bit Address feature set
104	F	0000h	Streaming Transfer Time – PIO
105	F	0008h	Maximum number of 512-byte blocks per DATA SET MANAGEMENT command
106	F	4000h	Physical sector size/Logical sector size
107	F	0000h	Inter-seek delay for ISO-7779 acoustic testing in microseconds
108-111	F	Varies	Reserved
112-115	X	000000000000 0000h	Reserved
116	X	0000h	Reserved
117-118	F	00000000h	Words per logical Sector
119	F	401Ch	Supported settings
120	F	401Ch	Command set/Feature Enabled/Supported
121-126	X	0h	Reserved
127	X	0h	Obsolete
128	F	0021h	Security status
129-159	V	Varies	Vendor specific
160	X	0h	Compact Flash Association (CFA) power mode 1
161-167	X	0h	Reserved for assignment by the CFA
168	V	Varies	Device Nominal Form Factor
169	F	0001h	DATA SET MANAGEMENT command is supported
170-173	F	0h	Additional Product Identifier
174-175	X	0h	Reserve
176-205	F	0h	Current media serial number
206	F	0039h	SCT Command Transport(

Word	F: Fixed V: Variable X: retired/obsolete /reserved	Default Value	Description
207-208	X	0h	Reserved
209	F	4000h	Alignment of logical blocks within a physical block
210-211	F	0000h	Write-Read-Verify Sector Count Mode 3 (not support)
212-213	F	0000h	Write-Read-Verify Sector Count Mode 2 (not support)
214-216	X	0000h	NV Cache relate (not support)
217	F	0001h	Non-rotating media device
218	X	0h	Reserved
219	X	0h	NV Cache relate (not support)
220	V	0h	Write read verify feature set current mode
221	X	0h	Reserved
222	F	10FFh	Transport major version number
223	F	0h	Transport minor version number
224-229	X	0h	reserved
230-233	F	0h	Extend number of user addressable sectors
234	F	0001h	Minimum number of 512-byte data blocks per DOWNLOAD MICROCODE command for mode 03h
235	F	FFFEh	Maximum number of 512-byte data blocks per DOWNLOAD MICROCODE command for mode 03h
236-242	X	0h	Reserved
243	X	0000h	Reserved
244-254	X	0h	Reserved
255	F	XXA5h XX is variable	Integrity word (Checksum and Signature)

■ List of Device Identification for Each Capacity

Capacity (GB)	*1 (Word 1/Word 54)	*2 (Word 57–58)	*3 (Word 60–61)	*4 (Word 100–103)
2	F39h	3BF070h	3BF070h	3BF070h
4	1E5Dh	778E30h	778E30h	778E30h
8	3CA5h	EEC9B0h	EEC9B0h	EEC9B0h
16	3FFFh	FBFC10h	1DD40B0h	1DD40B0h
30	3FFFh	FBFC10h	37E90F0h	37E90F0h
32	3FFFh	FBFC10h	3BA2EB0h	3BA2EB0h
60	3FFFh	FBFC10h	6FCCF30h	6FCCF30h
64	3FFFh	FBFC10h	7740AB0h	7740AB0h
120	3FFFh	FBFC10h	DF94BB0h	DF94BB0h
128	3FFFh	FBFC10h	EE7C2B0h	EE7C2B0h
240	3FFFh	FBFC10h	0FFFFFFFh	1BF244B0h
256	3FFFh	FBFC10h	0FFFFFFFh	1DCF32B0h
480	3FFFh	FBFC10h	0FFFFFFFh	37E436B0
512	3FFFh	FBFC10h	0FFFFFFFh	3B9E12B0h
960	3FFFh	FBFC10h	0FFFFFFFh	6FC81AB0h
1024	3FFFh	FBFC10h	0FFFFFFFh	773BD2B0h

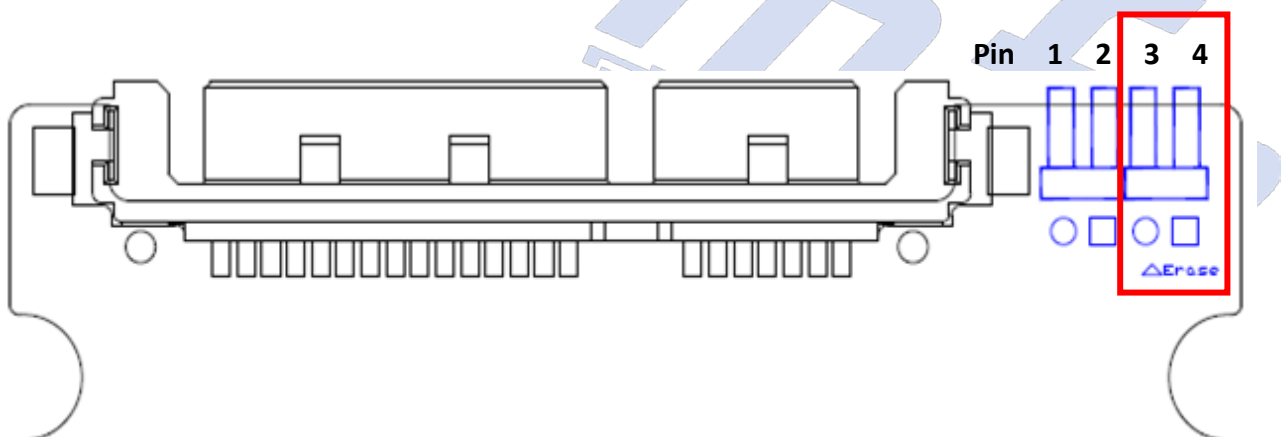
6.3. Write Protect Function (Optional)

The write protect function is triggered by pin3 and pin4 short of pin header. This used to set the device as a write protection device after power up. When the function is triggered, the data can't be written to the device. The device is then set as read only.

6.4. Quick Erase Function (Optional)

The Quick Erase is a special feature to allow users to erase user data of SSD by hardware trigger. When this feature is triggered by pin3 and pin4 short of pin header, the SSD controller will write all "0x00" to wipe all the data except firmware area, and the SSD will return to its factory default setting. This feature is particularly useful for emergent circumstances to quickly erase user data.

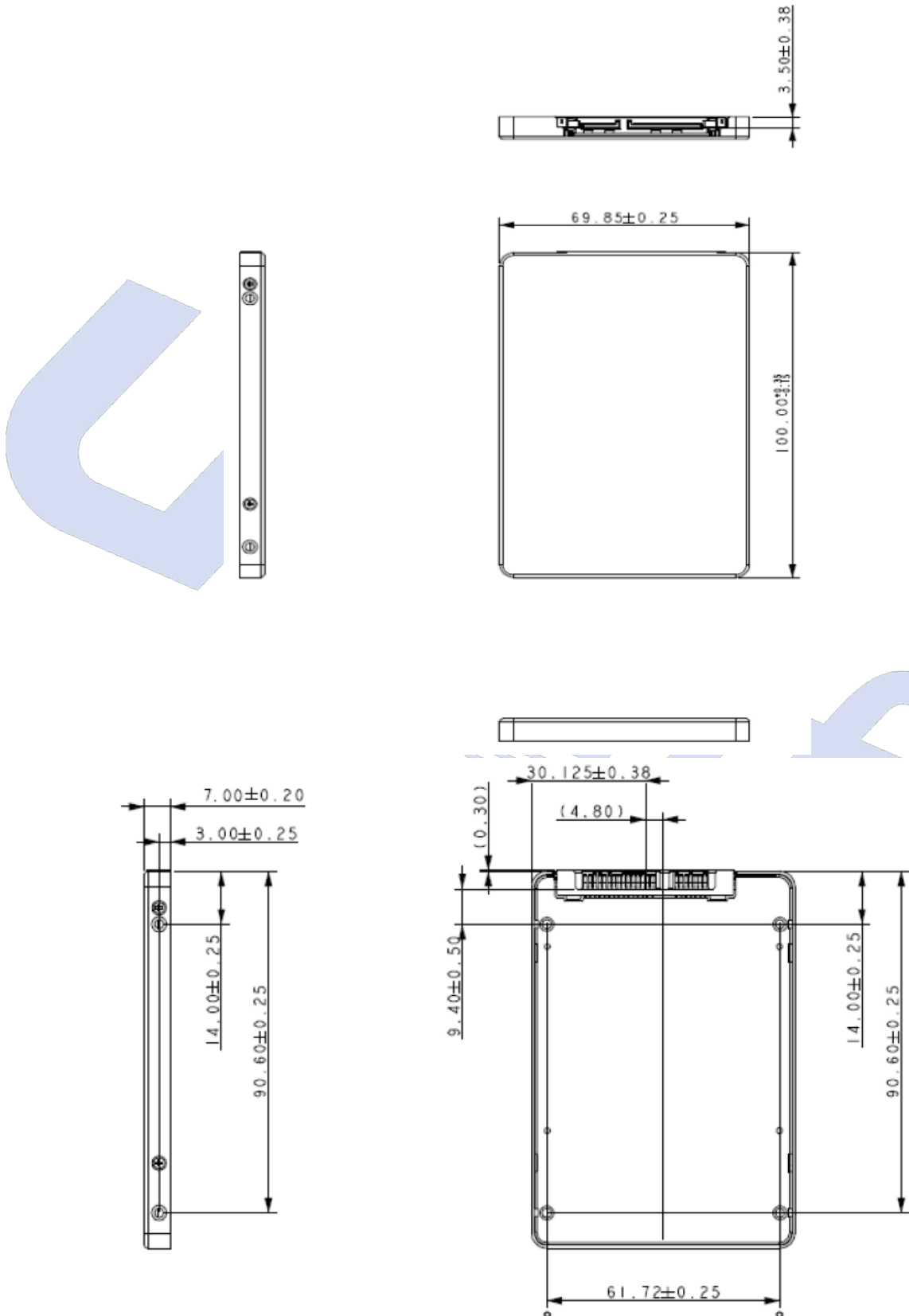
Note: These two functions can not be existed in one unit due to using the same GPIO.



7. PHYSICAL DIMENSION



Dimension: 100.10mm(L) x 69.85mm(W) x 7.00mm(H)



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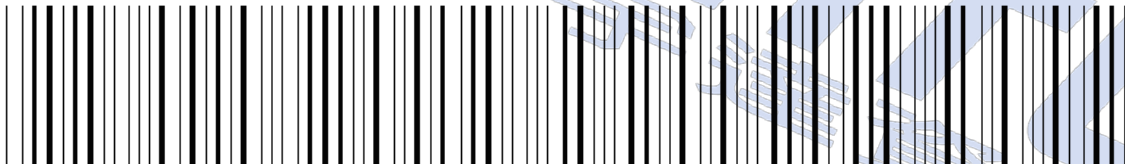
8. TERMINOLOGY



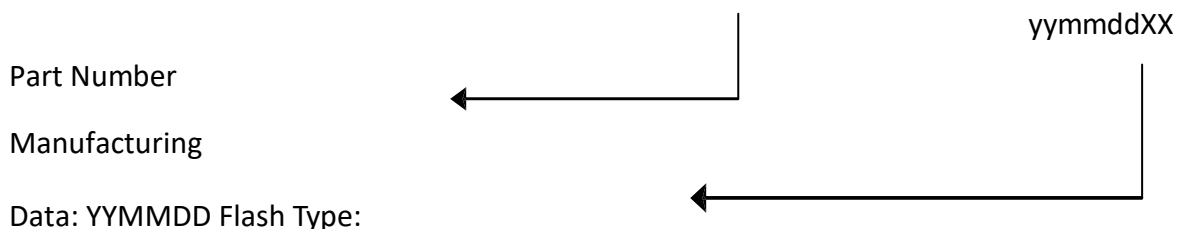
The following table is to list out the acronyms that have been applied throughout the document.

Term	Definitions
ATTO	Commercial performance benchmark application
DDR	Double data rate (SDRAM)
DIPM	Device initiated power management
HIPM	Host initiated power management
LBA	Logical block addressing
MB	Mega-byte
MTBF	Mean time between failures
NCQ	Native command queue
SATA	Serial advanced technology attachment
S.M.A.R.T.	Self-monitoring, analysis and reporting technology
SSD	Solid state disk

9. BARCODE DESCRIPTION



H F 3 2 5 U B 9 6 0 G B A 2 P



10. PARTNUMBER DECODER



HF3-25UBX⁸X⁹X¹⁰X¹¹X¹²X¹³X¹⁴X¹⁵X¹⁶X¹⁷

X ¹ X ² X ³	X ⁴ X ⁵	X ⁶ X ⁷	X ⁸ X ⁹ X ¹⁰ X ¹¹ X ¹²		X ¹³	X ¹⁴	X ¹⁵	X ¹⁶ X ¹⁷
HF3	25	UB	002GB	120GB	C: SLC Standard (0°C ~ +70°C)	2	P	blank
			004GB	128GB	I: SLC Industrial (-40°C ~ +85°C)			
			008GB	240GB	K: MLC Standard (0°C ~ +70°C)			
			016GB	256GB	M: MLC Industrial (-40°C ~ +85°C)			
			030GB	480GB	P: pSLC Standard (0°C ~ +70°C)			
			032GB	512GB	F: pSLC Industrial (-40°C ~ +85°C)			
			060GB	960GB	A: 3D TLC Standard (0°C ~ +70°C)			
			064GB	001TB	B: 3D TLC Industrial (-40°C ~ +85°C)			

X¹⁶X¹⁷

Blank: standard

01: Write Protection(WP)

03: Quick Erase Jumper(QEJ)

06: Conformal Coating(CC)

07: CC + WP

09: CC + QEJ